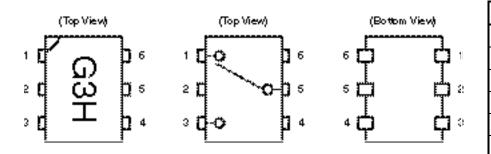
PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



| Pin No. | Pin Name | |
|---------|-----------------|--|
| 1 | OUTPUT1 | |
| 2 | GND | |
| 3 | OUTPUT2 | |
| 4 | Vcont | |
| 5 | INPUT | |
| 6 | V _{DD} | |

TRUTH TABLE

| Vcont | INPUT-OUTPUT1 | INPUT-OUTPUT2 |
|-------|---------------|---------------|
| Low | OFF | ON |
| High | ON | OFF |

ABSOLUTE MAXIMUM RATINGS (TA = +25°C, unless otherwise specified)

| Parameter | Symbol | Ratings | Unit |
|-------------------------------|-----------------|-------------|------|
| Supply Voltage | V _{DD} | +6.0 | V |
| Switch Control Voltage | Vcont | +6.0 | V |
| Input Power | Pin | +26 | dBm |
| Power Dissipation | PD | 150 Note | mW |
| Operating Ambient Temperature | TA | -45 to +85 | °C |
| Storage Temperature | Tstg | -55 to +150 | °C |

Note Mounted on double-sided copper-clad $50 \times 50 \times 1.6$ mm epoxy glass PWB, $T_A = +85^{\circ}C$

RECOMMENDED OPERATING RANGE (TA = +25°C, unless otherwise specified)

| Parameter | Symbol | MIN. | TYP. | MAX. | Unit |
|----------------------------|----------------------|------|------|------|------|
| Supply Voltage | V _{DD} | 2.7 | 2.8 | 3.0 | V |
| Switch Control Voltage (H) | V _{cont(H)} | 2.7 | 2.8 | 3.0 | ٧ |
| Switch Control Voltage (L) | V _{cont(L)} | -0.2 | 0 | 0.2 | V |

ELECTRICAL CHARACTERISTICS

(TA = +25°C, VDD = 2.8 V, Vcont = 2.8 V/0 V, DC cut capacitors = 56 pF, unless otherwise specified)

| Parameter | Symbol | Test Conditions | MIN. | TYP. | MAX. | Unit |
|---|-------------|--------------------|-------|-------|------|------|
| Insertion Loss1 | Lins1 | f = 0.5 to 1.0 GHz | - | 0.27 | 0.50 | dB |
| Insertion Loss2 | LINS2 | f = 2.0 GHz | - | 0.30 | 0.50 | dB |
| Isolation1 | ISL1 | f = 0.5 to 2.0 GHz | 24 | 30 | - | dB |
| Input Return Loss | RLin | f = 0.5 to 2.5 GHz | 15 | 20 | - | dB |
| Output Return Loss | RLout | f = 0.5 to 2.5 GHz | 15 | 20 | - | dB |
| 0.1 dB Gain Compression Input Power Note | Pin(0.1 dB) | f = 2.0 GHz | +17.5 | +20.5 | - | dBm |
| Supply Current | IDD | | - | 50 | 100 | μΑ |
| Switching Control Current | Icont | | _ | 4 | 20 | μΑ |

Note P_{in(0.1dB)} is measured the input power level when the insertion loss increases more 0.1 dB than that of linear range.

STANDARD CHARACTERISTICS FOR REFERENCE

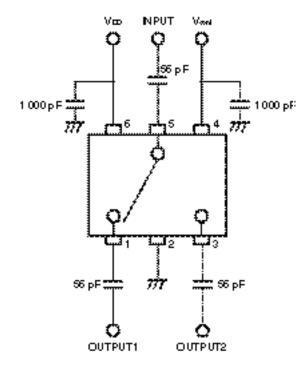
(TA = +25°C, VDD = 2.8 V,Vcont = 2.8 V/O V, DC cut capacitors = 56 pF, unless otherwise specified)

| Parameter | Symbol | Test Conditions | MIN. | TYP. | MAX. | Unit |
|---|-----------|-----------------|------|-------|------|------|
| Insertion Loss3 | LINS3 | f = 2.5 GHz | - | 0.30 | - | dB |
| Isolation2 | ISL2 | f = 2.5 GHz | - | 30 | - | dB |
| 1 dB Gain Compression Input Power Note | Pin(1 dB) | f = 2.0 GHz | - | +24.0 | - | dBm |
| Switching Control Speed | tsw | | - | 300 | - | ns |

Note P_{in(1dB)} is measured the input power level when the insertion loss increases more 1 dB than that of linear range.

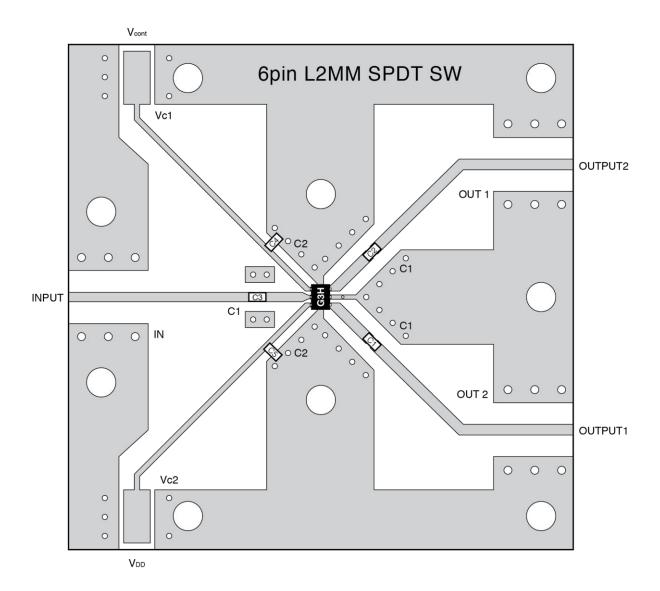
Caution This device is used it is necessary to use DC cut capacitors. The value of DC cut capacitors should be chosen to accommodate the frequency of operation, bandwidth, switching speed and the condition with actual board of your system. The range of recommended DC cut capacitor value is less than 100 pF.

EVALUATION CIRCUIT (VDD = 2.8 V, Vcont = 2.8 V/0 V, DC cut capacitors = 56 pF)



The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD

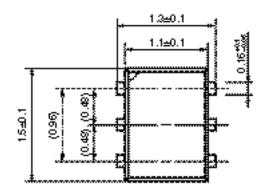


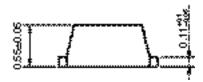
USING THE EVALUATION BOARD

| Symbol | Values |
|------------|----------|
| C1, C2, C3 | 56 pF |
| C4, C5 | 1 000 pF |

PACKAGE DIMENSIONS

6-PIN LEAD-LESS MINIMOLD (1511) (UNIT: mm)





Remark (): Reference value

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

| Soldering Method | Soldering Conditions | | Condition Symbol |
|------------------|---|---|------------------|
| Infrared Reflow | Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass) | : 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below | IR260 |
| VPS | Peak temperature (package surface temperature) Time at temperature of 200°C or higher Preheating time at 120 to 150°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass) | : 215°C or below : 25 to 40 seconds : 30 to 60 seconds : 3 times : 0.2%(Wt.) or below | VP215 |
| Wave Soldering | Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass) | : 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below | WS260 |
| Partial Heating | Peak temperature (pin temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass) | : 350°C or below : 3 seconds or less : 0.2%(Wt.) or below | HS350 |

Caution Do not use different soldering methods together (except for partial heating).

SAFETY INFORMATION ON THIS PRODUCT

| _ | |
|---|-------|
| | ution |
| | |

GaAs Products

The product contains gallium arsenide, GaAs.

GaAs vapor and powder are hazardous to human health if inhaled or ingested.

- Do not destroy or burn the product.
- Do not cut or cleave off any part of the product.
- Do not crush or chemically dissolve the product.
- Do not put the product in the mouth.

Follow related laws and ordinances for disposal. The product should be excluded from general industrial waste or household garbage.

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